Vishay Semiconductors

High Speed Infrared Emitting Diodes, 940 nm, Surface Emitter Technology



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DESCRIPTION

As part of the <u>SurfLight</u>TM portfolio, the VSMY294310 series are infrared, 940 nm emitting diodes based on GaAlAs surface emitter chip technology with extreme high radiant intensities, high optical power and high speed, molded in clear, untinted plastic packages (with lens) for surface mounting (SMD).

APPLICATIONS

- Miniature light barrier
- Photointerrupters
- · Optical switch
- Emitter source for proximity sensors
- IR illumination

FEATURES

- Package type: surface mount
- · Package form: GW, RGW
- Dimensions (L x W x H in mm): 2.3 x 2.3 x 2.55
- Peak wavelength: λ_p = 940 nm
- High reliability
- · High radiant power
- · Very high radiant intensity
- Angle of half intensity: $\varphi = \pm 25^{\circ}$
- · Suitable for high pulse current operation
- · Terminal configurations: gullwing or reverse gullwing
- Package matches with detector VEMD2503X01 series
- Floor life: 4 weeks, MSL 2a, acc. J-STD-020
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

PRODUCT SUMMARY				
COMPONENT	l _e (mW/sr)	φ (deg)	λ _p (nm)	t _r (ns)
VSMY294310RG	25	± 25	940	10
VSMY294310G	25	± 25	940	10

Note

Test conditions see table "Basic Characteristics"

ORDERING INFORMATION					
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM		
VSMY294310RG	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Reverse gullwing		
VSMY294310G	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Gullwing		

Note

· MOQ: minimum order quantity



COMPLIANT

HALOGEN FREE

<u>GREEN</u>

(5-2008)





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ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		V _R	5	V	
Forward current		I _F	70	mA	
Surge forward current	t _p = 100 μs	I _{FSM}	1	A	
Power dissipation		Pv	140	mW	
Junction temperature		Тj	100	°C	
Operating temperature range		T _{amb}	-40 to +85	°C	
Storage temperature range		T _{stg}	-40 to +100	°C	
Soldering temperature	Acc. figure 7, J-STD-020	T _{sd}	260	°C	
Thermal resistance junction/ambient	J-STD-051, soldered on PCB	R _{thJA}	250	K/W	

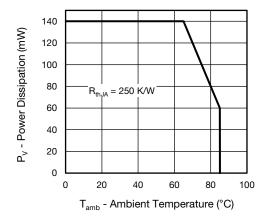
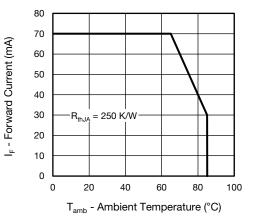


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature





BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 70 \text{ mA}, t_p = 20 \text{ ms}$	V _F	-	1.5	2.0	V
	I _F = 1 A, t _p = 100 μs	V _F	-	2.5	-	V
Temperature coefficient of V_F	I _F = 20 mA	TK _{VF}	-	-1.7	-	mV/K
Reverse current		I _R	not designed for reverse operation		μA	
Junction capacitance	$V_{R} = 0 V, f = 1 MHz, E = 0 mW/cm^{2}$	CJ	-	5	-	pF
Radiant intensity	I _F = 70 mA, t _p = 20 ms	l _e	12	25	45	mW/sr
	I _F = 1 A, t _p = 100 μs	l _e	-	260	-	mW/sr
Radiant power	I _F = 70 mA, t _p = 20 ms	фе	-	40	-	mW
Temperature coefficient of radiant power	I _F = 70 mA	ΤΚφ _e	-	-0.2	-	%/K
Angle of half intensity		φ	-	± 25	-	deg
Peak wavelength	I _F = 20 mA	λ _p	920	940	960	nm
Spectral bandwidth	I _F = 20 mA	Δλ	-	35	-	nm
Temperature coefficient of λ_p	I _F = 20 mA	ΤΚλ _p	-	0.25	-	nm/K
Rise time	I _F = 70 mA, 20 % to 80 %	t _r	-	10	-	ns
Fall time	I _F = 70 mA, 20 % to 80 %	t _f	-	10	-	ns

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BASIC CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)

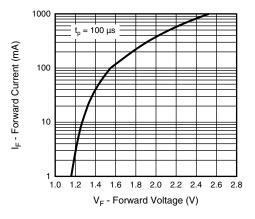


Fig. 3 - Forward Current vs. Forward Voltage

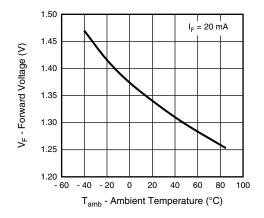


Fig. 4 - Forward Voltage vs. Ambient Temperature

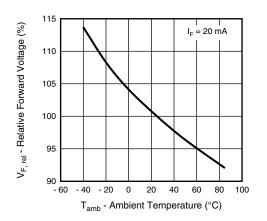


Fig. 5 - Relative Forward Voltage vs. Ambient Temperature

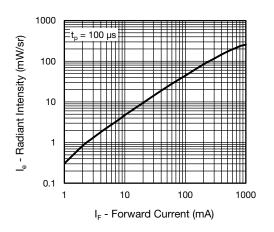


Fig. 6 - Radiant Intensity vs. Forward Current

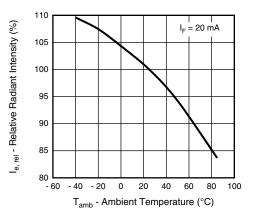


Fig. 7 - Relative Radiant Intensity vs. Ambient Temperature

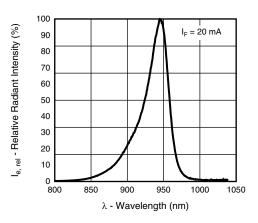


Fig. 8 - Relative Radiant Intensity vs. Wavelength

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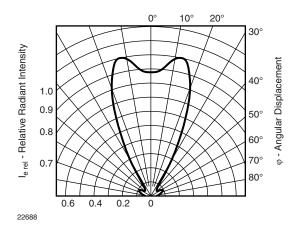


Fig. 9 - Relative Radiant Intensity vs. Angular Displacement

SOLDER PROFILE

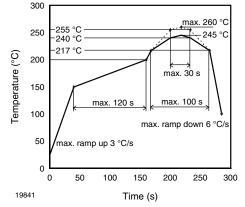


Fig. 10 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

VSMY294310RG, VSMY294310G

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DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 4 weeks

Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 2a, acc. to J-STD-020.

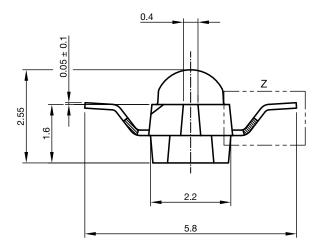
DRYING

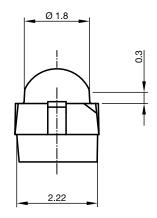
In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

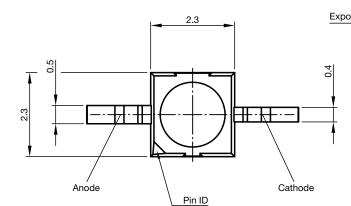


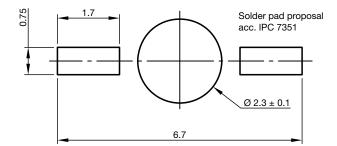
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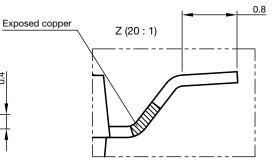
PACKAGE DIMENSIONS in millimeters: VSMY294310RG







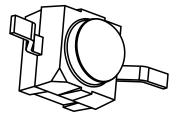






Technical drawings according to DIN specifications

Not indicated tolerances ± 0.2



Drawing-No.: 6.544-5409.03-4 Issue: 3; 02.10.15

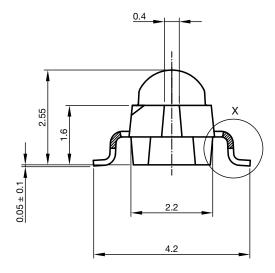
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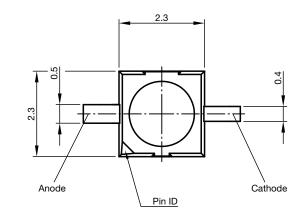
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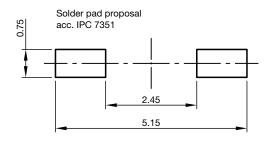


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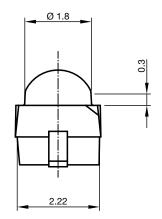
PACKAGE DIMENSIONS in millimeters: VSMY294310G

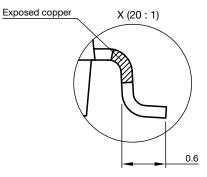






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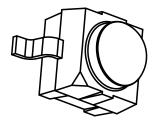






Technical drawings according to DIN specifications

Not indicated tolerances ± 0.2

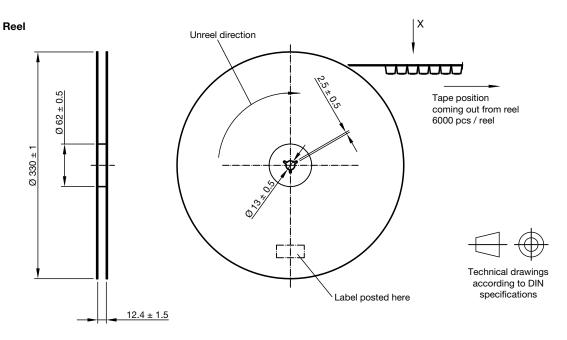


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TAPING AND REEL DIMENSIONS in millimeters: VSMY294310RG

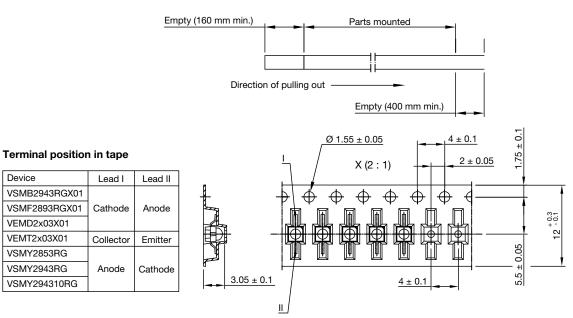
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Leader and trailer tape

Device

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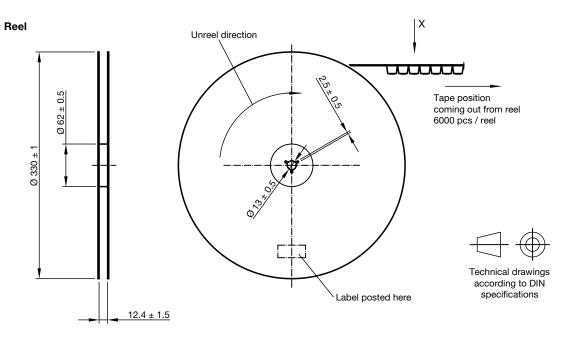


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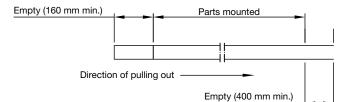
TAPING AND REEL DIMENSIONS in millimeters: VSMY294310G

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Leader and trailer tape

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Terminal position in tape Ø 1.55 ± 0.05 Device Lead I Lead II X (2:1) VSMB2943GX01 VSMF2893GX01 Cathode Anode \oplus \oplus \oplus \oplus Æ VEMD2x23X01 VEMT2x23X01 Collector Emitter VSMY2853G VSMY2943G Anode Cathode VSMY294310G

Drawing-No.: 9.800-5091.21-4 Issue: 3; 02.10.15

 1.75 ± 0.1 2 ± 0.05 Æ 5.5 ± 0.05 3.05 ± 0.1 4 ± 0.1 Ш

4 ± 0.1

0.3

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